

M54HC123/123A M74HC123/123A

DUAL RETRIGGERABLE MONOSTABLE MULTIVIBRATOR

- HIGH SPEED tPD = 25 ns (TYP) at VCC = 5V
- LOW POWER DISSIPATION STANDBY STATE I_{CC}=4 μ A (MAX.) AT T_A=25°C ACTIVE STATE I_{CC} = 200 μ A (TYP.) AT V_{CC}=5V
- HIGH NOISE IMMUNITY $V_{NIH} = V_{NIL} = 28 \% V_{CC}$ (MIN.)
- OUTPUT DRIVE CAPABILITY 10 LSTTL LOADS
- SYMMETRICAL OUTPUT IMPEDANCE I_{OH} = I_{OL} = 4 mA (MIN.)
- BALANCED PROPAGATION DELAYS tPLH = tPHL
- WIDE OPERATING VOLTAGE RANGE V_{CC} (OPR) = 2 V TO 6 V
- WIDE OUTPUT PULSE WIDTH RANGE twout = 120 ns ~ 60 s OVER AT V_{CC} = 4.5 V
- PIN AND FUNCTION COMPATIBLE WITH 54/74LS123

DESCRIPTION

The M54/74HC123 is a high speed CMOS MONO-STABLE multivibrator fabricated with silicon gate C²MOS technology. It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation. There are two trigger inputs, \overline{A} INPUT (negative edge) and 8 INPUT (positive edge). These inputs are valid for slow rising/falling signals, (tr = tf = I sec). The device may also be triggered by using the CLR input (positive-edge) because of the Schmitt-trigger input ; after triggering the output maintains the MONO-STABLE state for the time period determined by the external resistor Rx and capacitor Cx. When $Cx \ge$ 10nF and $Rx \ge 10K\Omega$, the output pulse width value is approximatively given by the formula: $t_{w(out)} = K$ • Cx • Rx.

Two different pulse width constant are available:

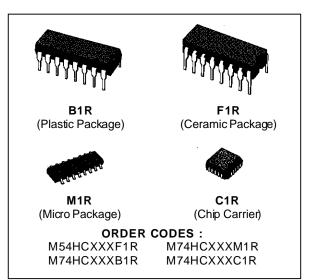
 $K \cong 0.45 \text{ for HC123} \quad K \cong 1 \text{ for HC123A}.$

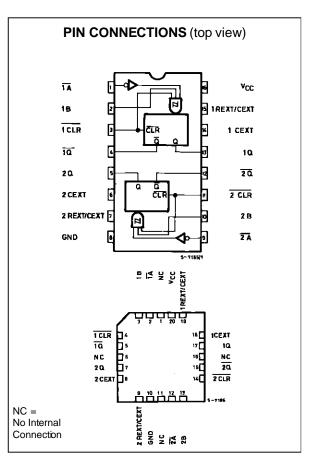
Taking $\overline{\text{CLR}}$ low breaks this MONOSTABLE STATE. If the next trigger pulse occurs during the MONOSTABLE period it makes the MONOSTABLE period longer. Limit for values of Cx and Rx : Cx : NO LIMIT

Rx : V_{CC} < 3.0 V 5 K Ω to 1 M Ω

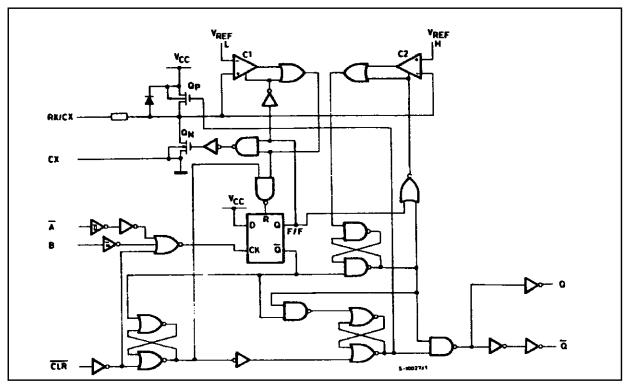
 $V_{CC} \ge 3.0 \text{ V} 1 \text{ K} \Omega \text{ to } 1 \text{ M} \Omega$

All inputs are equipped with protection circuits

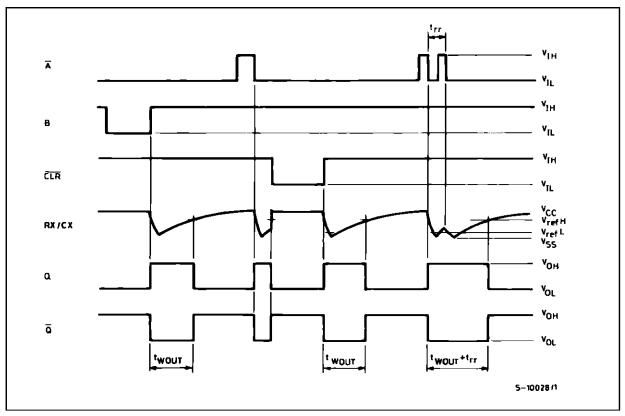




SYSTEM DIAGRAM

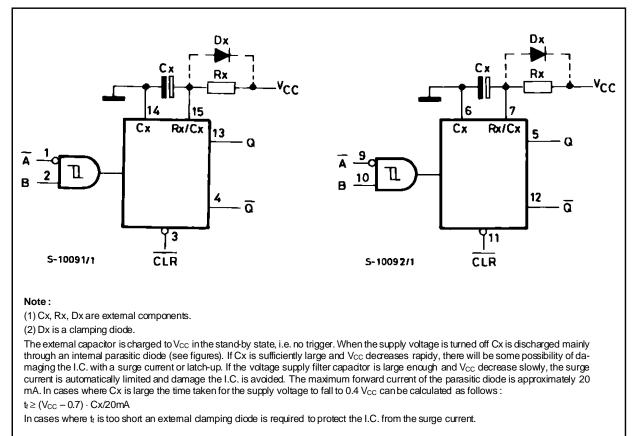


TIMING CHART





BLOCK DIAGRAM



FUNCTIONAL DESCRIPTION

STAND-BY STATE

The external capacitor, Cx, is fully charged to V_{CC} in the stand-by state. Hence, before triggering, transistor Qp and Qn (connected to the Rx/Cx node) are both turned-off. The two comparators that control the timing and the two reference voltage sources stop operating. The total supply current is therefore only leakage current.

TRIGGER OPERATION

Triggering occurs when :

- 1 st) A is "low" and B has a falling edge;
- 2 nd) B is "high" and A has a rising edge ;

3 rd) A is low and B is high and C1 has a rising edge.

After the multivibrator has been retriggered comparator C1 and C2 start operating and Qn is turned on. Cx then discharges through Qn. The voltage at the node R/C external falls. When it reaches V_{REFL} the output of comparator C1 becomes low. This in turn resets the flip-flop and Qn is turned off.

At this point C1 stops functioning but C2 continues to operate.

The voltage at R/C external begins to rise with a time constant set by the external components Rx, Cx.

Triggering the multivibrator causes Q to go high after internal delay due to the flip-flop and the gate. Q remains high until the voltage at R/C external rises again to V_{REFH}. At this point C2 output goes low and O goes low. C2 stop operating. That means that after triggering when the voltage R/C external returns to V_{REFH} the multivibrator has returned to its MONOSTABLE STATE. In the case where Rx · Cx are large enough and the discharge time of the capacitor and the delay time in the I.C. can be ignored, the width of the output pulse tw (out) is as follows :

 $t_{W(OUT)} = 0.46 \text{ Cx} \cdot \text{Rx} (\text{HC123})$ $t_{W(OUT)} = \text{Cx} \cdot \text{Rx} (\text{HC123A})$



FUNCTIONAL DESCRIPTION (continued)

RE-TRIGGERED OPERATION

When a second trigger pulse follows the first its effect will depend on the state of the multivibrator. If the capacitor Cx is being charged the voltage level of R/C external falls to Vrefl again and Q remains high i.e. the retrigger pulse arrives in a time shorter than the period $Rx \cdot Cx$ seconds, the capacitor charging time constant. If the second trigger pulse is very close to the initial trigger pulse it is ineffective; i.e. the second trigger must arrive in the capacitor discharge cycle to be ineffective; Hence the mini-

mum time for a second trigger to be effective depends on V_{CC} and Cx.

RESET OPERATION

CL is normally high. If CL is low, the trigger is not effective because Q output goes low and trigger control flip-flop is reset.

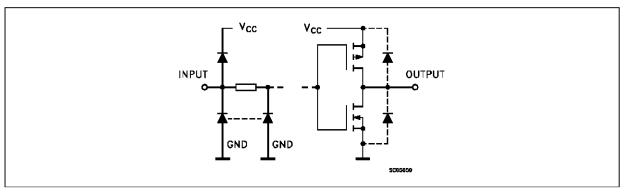
Also transistor Op is turned on and Cx is charged quicky to V_{CC} . This means if CL input goes low, the IC becomes waiting state both in operating and non operating state.

TRUTH TABLE

			PUTS	NOTE		
В	CL	Ø	Ø	NOTE		
Н	Н			OUTPUT ENABLE		
L	Н	L	Н	INHIBIT		
Х	Н	L	Н	INHIBIT		
	Н			OUTPUT ENABLE		
Н				OUTPUT ENABLE		
Х	L	L	Н	INHIBIT		
		Н Н L Н X Н _ Н H _ X L	H H L H L X H L J H H J X L L	H H L H L X H L J H H X L H X H X L H X L L H L X L H		

X: Don't Care Z: High Impedance

INPUT AND OUTPUT EQUIVALENT CIRCUIT

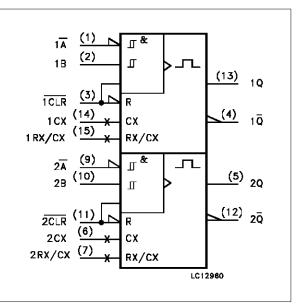




PIN No	SYMBOL	NAME AND FUNCTION
1, 9	1Ā, 2Ā	Trigger Inputs (Negative Edge Triggered)
2, 10	1B, 2B	Trigger Inputs (Positive Edge Triggered)
3, 11	1 <u>CLR,</u> 2CLR	Direct Reset LOW and Trigger Action at Positive Edge
4, 12	1 <u>Q</u> , 2 <u>Q</u>	Outputs (Active LOW)
7	2R _{EXT} /C _{EXT}	External Resistor Capacitor Connection
13, 5	1Q, 2Q	Outputs (Active HIGH)
14, 6	1C _{EXT} 2C _{EXT}	External Capacitor Connection
15	1R _{EXT} /C _{EXT}	External Resistor Capacitor Connection
8	GND	Ground (0V)
16	Vcc	Positive Supply Voltage

PIN DESCRIPTION

IEC LOGIC SYMBOL



ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage	-0.5 to +7	V
VI	DC Input Voltage	-0.5 to V _{CC} + 0.5	V
Vo	DC Output Voltage	-0.5 to V _{CC} + 0.5	V
I _{IK}	DC Input Diode Current	± 20	mA
I _{OK}	DC Output Diode Current	± 20	mA
lo	DC Output Source Sink Current Per Output Pin	± 25	mA
Icc or I _{GND}	DC V _{CC} or Ground Current	± 50	mA
PD	Power Dissipation	500 (*)	mW
T _{stg}	Storage Temperature	-65 to +150	°C
TL	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied. (*) 500 mW: \cong 65 °C derate to 300 mW by 10mW/°C: 65 °C to 85 °C



Symbol	Parameter		Value	Unit	
Vcc	Supply Voltage		2 to 6	V	
VI	Input Voltage	Voltage			
Vo	Output Voltage	utput Voltage			
T _{op}	Operating Temperature: M54HC Series M74HC Series	-55 to +125 -40 to +85	°C ℃		
t _r , t _f	Input Rise and Fall Time	nput Rise and Fall Time 0 to 1000			
		[
		0 to 400			
Cx	External Capacitor		NO LIMITATION	pF	
Rx	External Resistor	$V_{CC} < 3 V$	5K to 1M	Ω	
		$V_{CC} \ge 3 V$	1K to 1M		

RECOMMENDED OPERATING CONDITIONS

(*) The maximum allowable values of Cx and Rx are a function of leakage of capacitor Cx, the leakage of device and leakage due to the board layout and surface resistance. Susceptibility to externally induced noise may occur for $Rx > 1M\Omega$

DC SPECIFICATIONS

		Test Conditions		Value								
Symbol	Parameter	Vcc (V)				_A = 25 ^c C and 7			85 °C HC	1	125 °C HC	Unit
		(v)			Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
VIH	High Level Input	2.0			1.5			1.5		1.5		
	Voltage	4.5			3.15			3.15		3.15		V
		6.0			4.2			4.2		4.2		
VIL	Low Level Input	2.0					0.5		0.5		0.5	
	Voltage	4.5					1.35		1.35		1.35	V
		6.0					1.8		1.8		1.8	
Vон	High Level	2.0	VI =		1.9	2.0		1.9		1.9		
	Output Voltage	4.5		VII- VIH or VIL I _O =-20 μA 		4.5		4.4		4.4		
		6.0	or			6.0		5.9		5.9		V
		4.5	ViL			4.31		4.13		4.10		
		6.0		l ₀ =-5.2 mA	5.68	5.8		5.63		5.60		
V _{OL}	Low Level Output	2.0	V	$V_{I} = $ $I_{O} = 20 \ \mu A$		0.0	0.1		0.1		0.1	
	Voltage	4.5	VII			0.0	0.1		0.1		0.1	
		6.0	or			0.0	0.1		0.1		0.1	V
		4.5	Vil	I _O = 4.0 mA		0.17	0.26		0.33		0.40	
		6.0		l ₀ = 5.2 mA		0.18	0.26		0.33		0.40	
lı	Input Leakage Current	6.0	$V_I = V_{CC}$ or GND				±0.1		±1		±1	μA
I	R/C Terminal Off State Current	6.0	$V_I = V_{CC}$ or GND				±0.1		±1		±1	μA
I _{CC}	Quiescent Supply Current	6.0	$V_I = V_{CC}$ or GND				4		40		80	μA
Icc'	Active State	2.0		V _{CC} or GND		45	200		260		320	μΑ
	Supply Current (1)	4.5		n 7 or 15		500	600		780		960	μA
		6.0		$V = V_{CC}/2$		0.7	1		1.3		1.6	mA

(1): Per Circuit



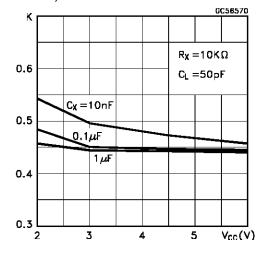
		Те	est Conditions				Value				
Symbol	Parameter	V _{cc}			A = 25 °C and 7			85 °C HC		125 °C HC	Unit
		(V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
t _{TLH}	Output Transition	2.0			30	75		95		110	
t _{THL} Time	4.5			8	15		19		22	ns	
		6.0			7	13		16		19	
t _{PLH}	Propagation	2.0			102	210		265		315	
t _{PHL}	Delay Time	4.5			29	42		53		63	ns
	(Ā, B - Q, Q)	6.0			22	36		45		54	
t _{PLH}	Propagation	2.0			102	235		295		355	
tPHL	Delay Time	4.5			31	47		59		71	ns
	$(\overline{\text{OLR}} \text{TRIGGER} - \text{Q}, \overline{\text{Q}})$	6.0			23	40		50		60	
t _{PLH}	Propagation	2.0			68	160		200		240	
tPHL	Delay Time	4.5			20	32		40		48	ns
	$(\overline{CLR} - Q, \overline{Q})$	6.0			16	27		34		41	
twouт	Output Pulse	2.0	C _X = 100 pF		1.4						
10001	Width	4.5	$R_X = 10 \text{ K}\Omega$		1.2						μs
	(for HC123)	6.0			1.1						•
	2.0	C _X = 0.1 μF		4.6							
	4.5	$R_X = 100 \text{ K}\Omega$		4.4						ms	
		6.0	~		4.3						
t _{WOUT} Output Pulse Width (for HC123A)	2.0	C _X = 100 pF		1.9							
		4.5	$R_X = 10 \text{ K}\Omega$		1.6						μs
		6.0			1.5						
		2.0	C _X = 0.1 μF		9.8						
		4.5	$R_{X} = 100 \text{ K}\Omega$		9.5						ms
		6.0			9.5						e
A the second	Output Pulse	0.0			9.4 ±1						
Δtwout	Width Error Between Circuits in Same Package				ΞI						%
t _{W(H)}	Minimum Pulse	2.0				75		95		110	
t _{W(L)}	Width	4.5				15		19		22	ns
		6.0				13		16		19	
t _{W(L)}	Minimum Pulse	2.0				75		95		110	
()	Width (CLR)	4.5				15		19		22	ns
		6.0				13		16		19	
t _{rr} Minimum Retrigger Tir	Minimum	2.0	C _X = 100 pF		325						
	Retrigger Time	4.5 $R_X = 1 K\Omega$		108						ns	
		6.0			78						
		2.0	C _X = 0.1 μF		5						
		4.5	$R_X = 100 \text{ K}\Omega$		1.4						μs
		6.0			1.2						
CIN	Input Capacitance				5	10		10		10	pF
C _{PD} (*)	Power Dissipation				162						pF
	Capacitance										

AC ELECTRICAL CHARACTERISTICS ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

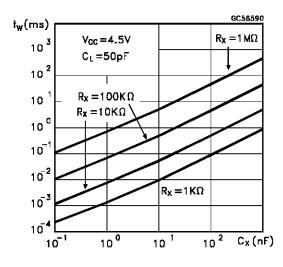
(*) C_{PD} is defined as the value of the IC's internal equivalent capaditance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operting current can be obtained by the following equation. $I_{CC}(opr) = C_{PD} \bullet V_{CC} \bullet I_{IN} + I_{CC}$ Duty/100 + $I_C/2$ (per monostable) (I_{CC} : Active Supply Current) (Duty:%)



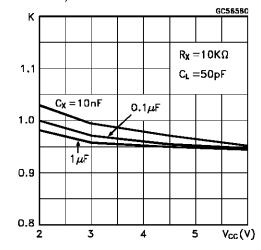
Output Pulse Width Constant Characteristics (for HC123)

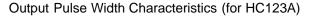


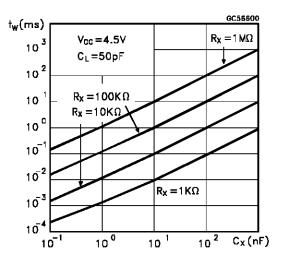
Output Pulse Width Characteristics (for HC123)



Output Pulse Width Constant Characteristics (for HC123A)

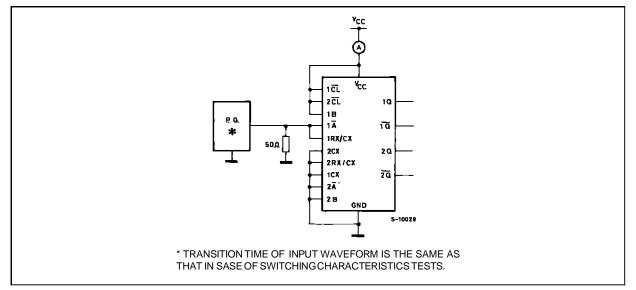




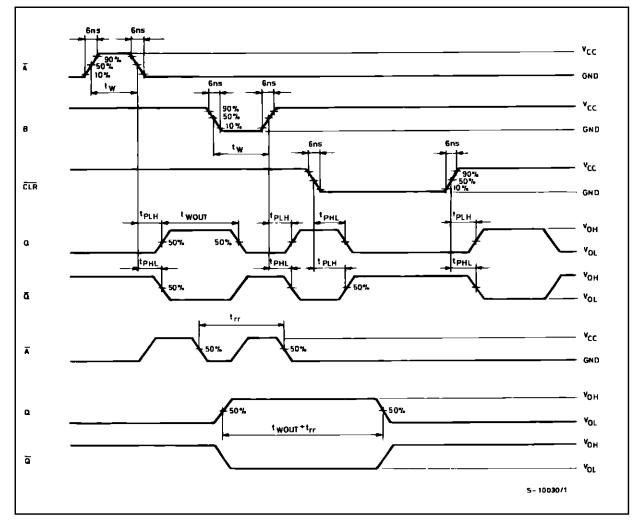




TEST CIRCUIT Icc (Opr)



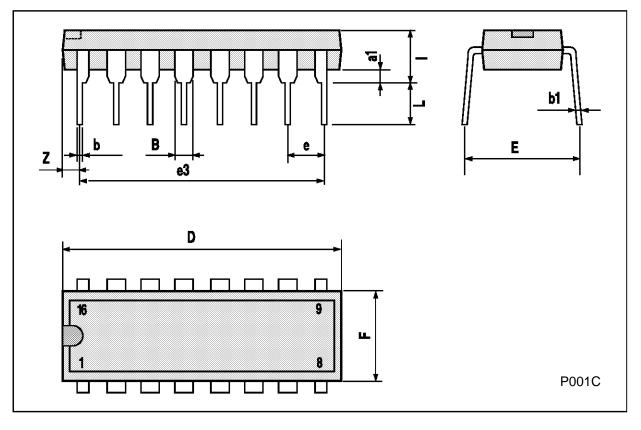
SWITCHING CHARACTERISTICS TEST WAVEFORM





Plastic DIP16 (0.25) MECHANICAL DATA	
Plastic DIP16 (0.25) MECHANICAL DATA	
Plastic DIP 6 (0.25) MECHANICAL DATA	
FIASUL DIFICIU.20 WECHANICAL DATA	
FIASLIC DIFICIU.231 WECHANICAL DATA	
FIDSUL DIFIUUU.231 NILCI ANICAL DATA	

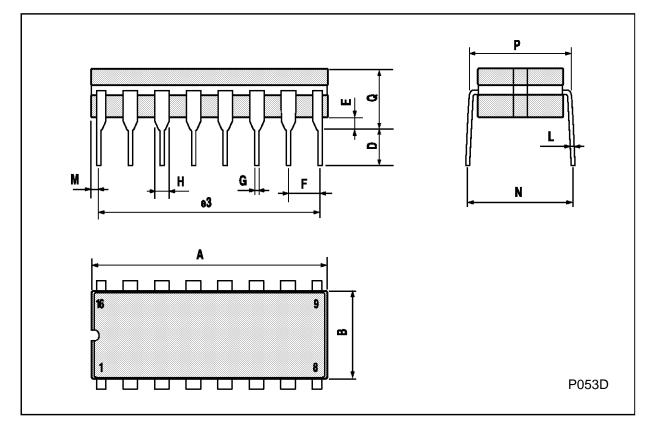
DIM.		mm			inch	
Dim	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
В	0.77		1.65	0.030		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
е		2.54			0.100	
e3		17.78			0.700	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z			1.27			0.050





DIM.		mm			inch	
Dim.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			20			0.787
В			7			0.276
D		3.3			0.130	
E	0.38			0.015		
e3		17.78			0.700	
F	2.29		2.79	0.090		0.110
G	0.4		0.55	0.016		0.022
Н	1.17		1.52	0.046		0.060
L	0.22		0.31	0.009		0.012
М	0.51		1.27	0.020		0.050
Ν			10.3			0.406
Р	7.8		8.05	0.307		0.317
Q			5.08			0.200

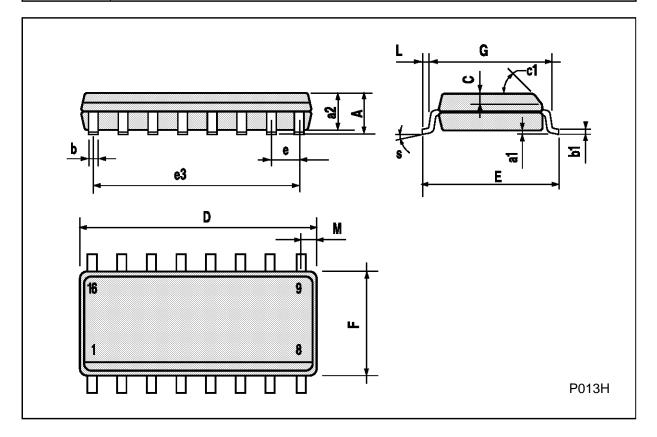
Ceramic DIP16/1 MECHANICAL DATA





DIM.		mm			inch	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			1.75			0.068
a1	0.1		0.2	0.004		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
С		0.5			0.019	
c1			45°	(typ.)		
D	9.8		10	0.385		0.393
Е	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		8.89			0.350	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
М			0.62			0.024

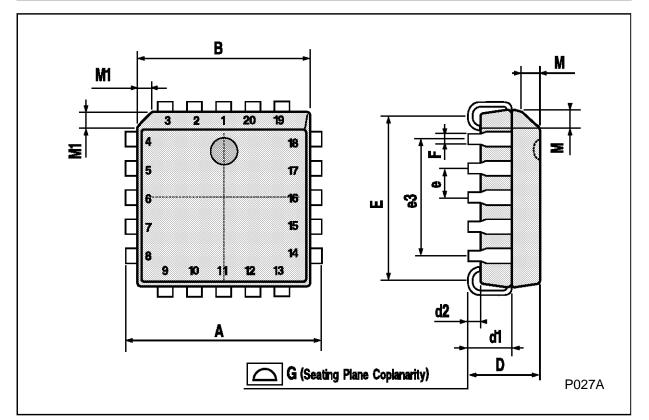
SO16 (Narrow) MECHANICAL DATA





DIM.		mm			inch	
Dim.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	9.78		10.03	0.385		0.395
В	8.89		9.04	0.350		0.356
D	4.2		4.57	0.165		0.180
d1		2.54			0.100	
d2		0.56			0.022	
E	7.37		8.38	0.290		0.330
е		1.27			0.050	
e3		5.08			0.200	
F		0.38			0.015	
G			0.101			0.004
М		1.27			0.050	
M1		1.14			0.045	

PLCC20 MECHANICAL DATA



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